



鼎日株式會社

Ding Day Co., LTD.

DTS2300

N-Channel Enhancement Mode Field Effect Transistor

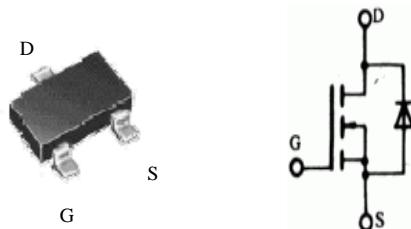
FEATURES

- Super high dense cell design for low R_{DS(ON)}
- Rugged and reliable
- Simple drive requirement
- SOT-23 package

PRODUCT SUMMARY		
V _{DSS}	I _D	R _{DS(ON)} (mΩ) Typ
20V	4.5A	24 @ V _{GS} =4.5V
		38 @ V _{GS} =2.5V



NOTE: The DTS2300 is available in a lead-free package



ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	20	V
Gate-Source Voltage	V _{GS}	±8	V
Drain Current-Continuous ^a @ T _j =125°C - Pulse d ^b	I _D	4.5	A
	I _{DM}	12	A
Drain-source Diode Forward Current ^a	I _S	1.25	A
Maximum Power Dissipation ^a	P _D	1.25	W
Operating Junction and Storage Temperature Range	T _j , T _{STG}	-55 to 150	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to Ambient ^a	R _{th JA}	100	°C/W
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ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BVDSS	VGS=0V, ID=250μA	20			V
Zero Gate Voltage Drain Current	IDSS	VDS=16V, VGS=0V			1	μA
Gate-Body Leakage	IGSS	VGS=±8V, VDS=0V			±100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	VGS(th)	VDS=VGS, ID=250μA	0.5	0.8	1.5	V
Drain-Source On-State Resistance	RDS(ON)	VGS=4.5V, ID=2.8A		28	33	mΩ
		VGS=2.5V, ID=2.0A		38	42	
Forward Transconductance	gFS	VGS=7V, ID=5A		5		S
DAYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ISS}	VDS=10V, VGS=0V f=1.0MHz		608		pF
Output Capacitance	C _{OSS}			115		pF
Reverse Transfer Capacitance	C _{rss}			86		pF
SWITCHING CHARACTERISISTICS						
Turn-On Delay Time	t _{D(ON)}	V _{DD} =10V ID=3.6A, V _{GEN} =4.5V R _L =10ohm R _{GEN} =10ohm		10		ns
Rise Time	tr			14		ns
Turn-Off Delay Time	t _{D(OFF)}			39		ns
Fall Time	tf			26		ns
Total Gate Charge	Q _g	VDS=10V, ID=1A VGS=4.5V		9.2		nC
Gate-Source Charge	Q _{gs}			1.6		nC
Gate-Drain Charge	Q _{gd}			2.6		nC

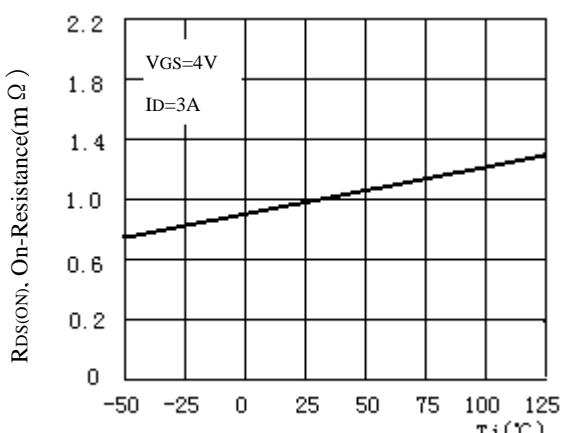
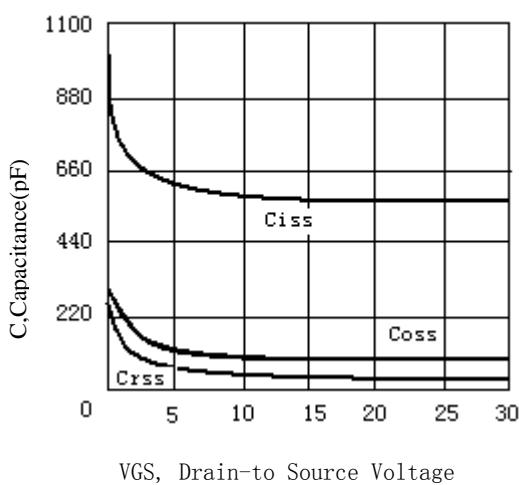
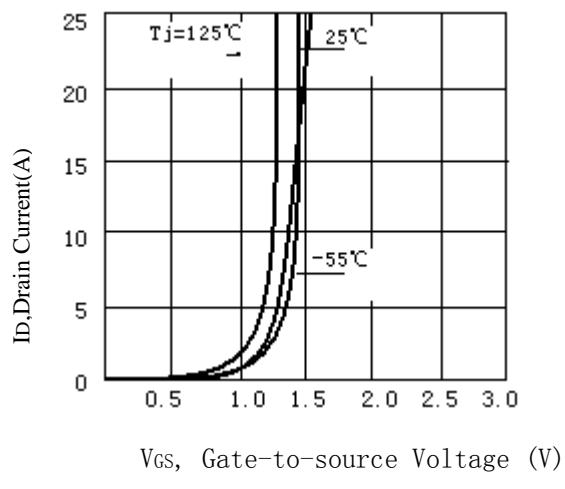
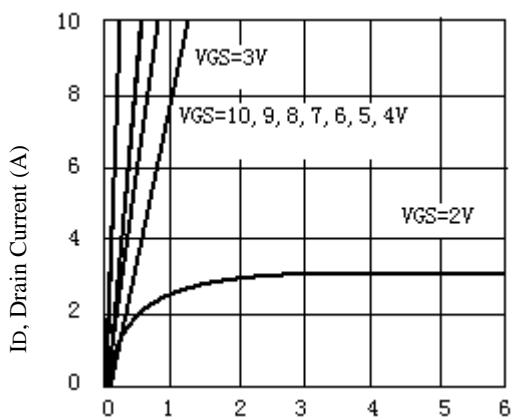
DTS2300

ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS						
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =1.25A		0.84	1.3	V

Notes

- a. Surface Mounted on FR4 Board, t ≤ 10sec
- b. Pulse Test: Pulse Width ≤ 300Us, Duty ≤ 2%
- c. Guaranteed by design, not subject to production testing.



DTS2300

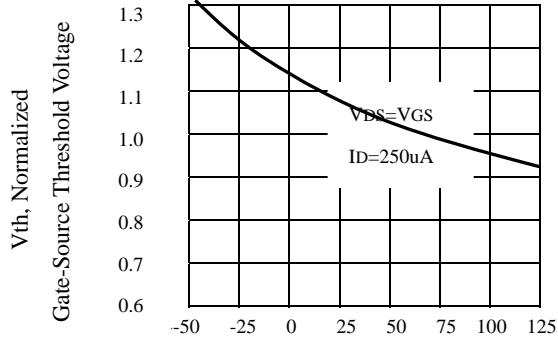


Figure5.Gate Threshold Variation
With Temperature

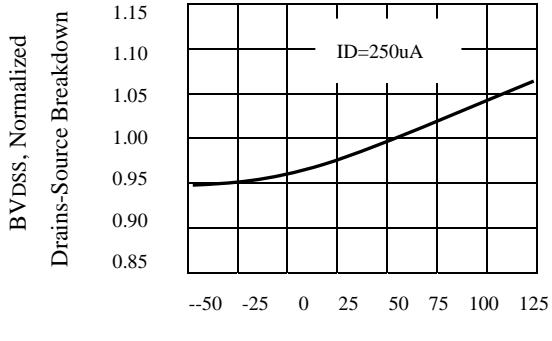


Figure6.Breakdown Voltage Variation
With Temperature

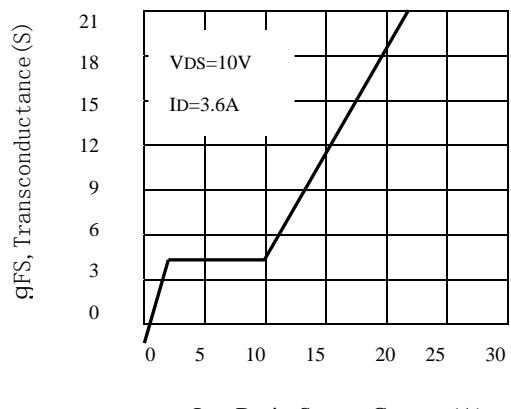


Figure7.Transconductance Variation
With Drain Current

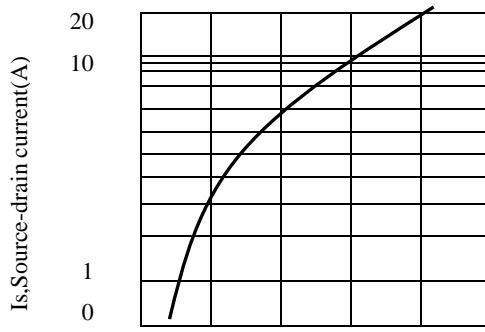


Figure8.Body Diode Forward Voltage
Variation with Source Current

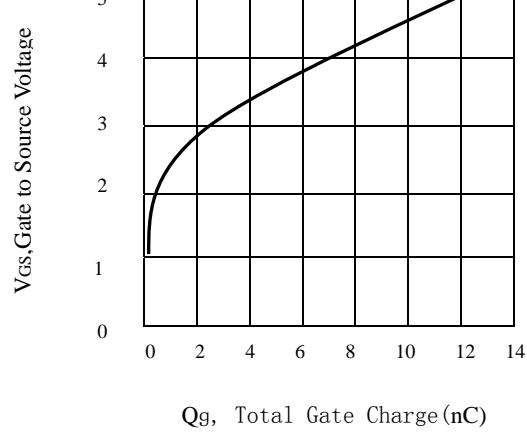


Figure9. Gate Charge

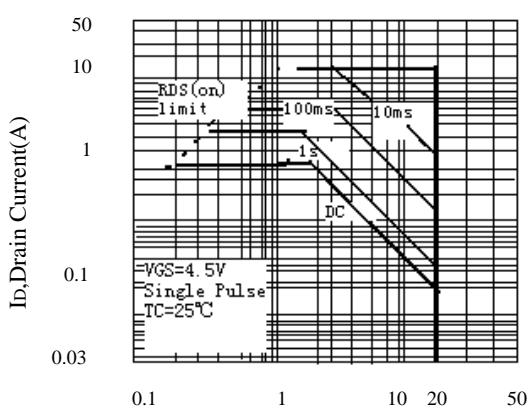


Figure10.Maximum Safe Operating Area